

MOLDING POWER INDUCTORS**1. Features**

- High rated current
- Frequency up to 3MHz
- 125°C maximum total temperature operation
- Low core loss
- Ultra low buzz noise due to molding construction
- Halogen Free & ROHS compliant

2. Applications

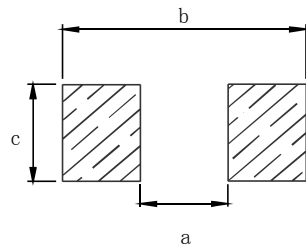
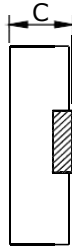
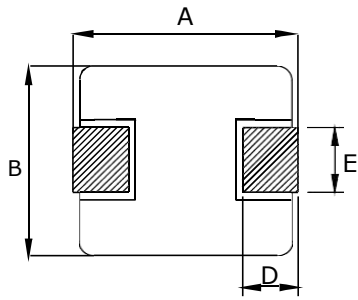
- Laptops and PCs
- Switch and servers
- Base stations
- DC/DC converters
- Battery powered devices
- SSD modules

**3. Product Identification**

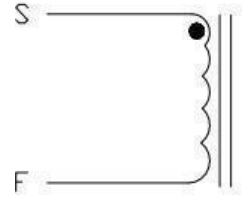
XR XXXX --- XXX M
① ② ③ ④

- ① Series name
- ② Dimensions and shape (0412~1265)
- ③ Inductance Value
- ④ Inductance Tolerance (M= ± 20%)

4. Dimensions (unit:mm)



Recommend Land Pattern



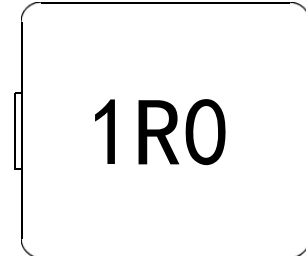
SCHEMATIC DRAWING

| series | A | B | C | D | E | a typ | b typ | c typ |
|--------|---------|---------|---------|---------|---------|-------|-------|-------|
| XR0650 | 7.0±0.3 | 6.6±0.2 | 4.8±0.2 | 1.6±0.3 | 3.0±0.3 | 3.7 | 8.4 | 3.5 |

5. Marking

The inductor is marked with a 3-digit code

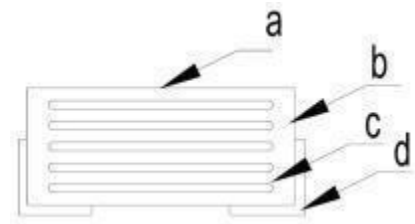
| Nominal Inductance | |
|--------------------|---------------|
| Example | Nominal Value |
| 1R0 | 1.0 μ H |
| 100 | 10 μ H |
| 101 | 100 μ H |



Note : Using Ink for marking

6. Structure and Components

| Symbol | Components | Material |
|--------|------------|--------------------------|
| a | MARKING | Ink(black) |
| b | CORE | Alloy Sponge Powder |
| c | WIRE | Polyurethane copper wire |
| d | Terminal | Copper plated with Sn |



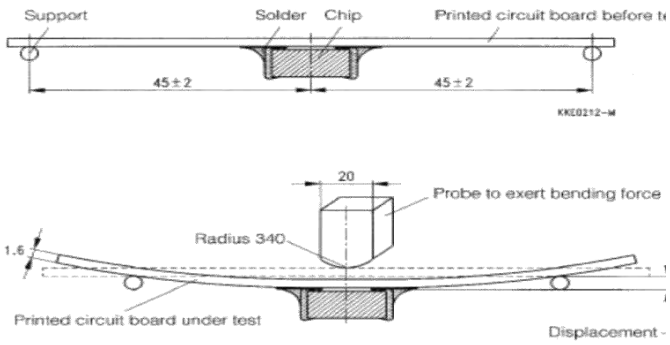
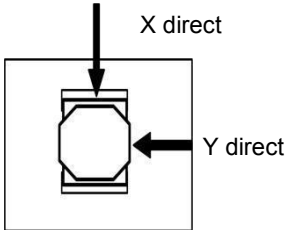
7. Electrical characteristics

•XR0650 TYPE:

| Part No. | Inductance | DC Resistance | Saturation Current | Heating Rating Current |
|-------------|--------------------|---------------|--------------------|------------------------|
| | L0 (μH) | DCR (m) | Isat (A) | Irms (A) |
| | ±20 %, 100 kHz, 1V | MAX. | TYP. | TYP. |
| XR0650-R47M | 0.47 | 3.9 | 21.0 | 20 |
| XR0650-R68M | 0.68 | 4.5 | 18.0 | 16.5 |
| XR0650-1R0M | 1.0 | 6.6 | 16.0 | 12 |
| XR0650-1R5M | 1.5 | 10 | 13.0 | 9.5 |
| XR0650-2R2M | 2.2 | 12.5 | 11.0 | 9 |
| XR0650-3R3M | 3.3 | 22.0 | 10.0 | 8.5 |
| XR0650-4R7M | 4.7 | 29 | 8 | 6 |
| XR0650-5R6M | 5.6 | 35 | 6.8 | 6 |
| XR0650-6R8M | 6.8 | 41 | 6.3 | 5.8 |
| XR0650-8R2M | 8.2 | 48 | 5.5 | 5.5 |
| XR0650-100M | 10 | 60 | 5.3 | 4.5 |
| XR0650-150M | 15 | 90 | 4.0 | 3.1 |
| XR0650-220M | 22 | 140 | 3.5 | 2.6 |
| XR0650-330M | 33 | 190 | 3.0 | 2.3 |
| XR0650-470M | 47 | 230 | 2.6 | 2.0 |
| XR0650-680M | 68 | 360 | 2.2 | 1.7 |
| XR0650-820M | 82 | 480 | 2.1 | 1.6 |
| XR0650-101M | 100 | 595 | 2.0 | 1.5 |

8. Reliability Test

| Item | Specification and Requirement | Test Method | | | | | | | | |
|-------------------------|---|--|------------|---------|-----------------|-------|-----------------|----------------------|------|---------------------------------|
| Solderability | 1. No case deformation or change in appearance 2. New solder coverage More than 90% | 1. Preheat: $155^{\circ}\text{C} \pm 5^{\circ}\text{C}$, $60\text{S} \pm 2\text{S}$ 2. Tin: lead-free. 3. Temperature: $245^{\circ}\text{C} \pm 5^{\circ}\text{C}$, flux $3.0\text{S} \pm 0.5\text{S}$. | | | | | | | | |
| Mechanical shock | 1. No case deformation or change in appearance 2. $\Delta\text{L}/\text{Lo} \leq \pm 10\%$ | 1. Acceleration: 100G 2. Pulse time: 6ms 3. 3 times in each positive and negative direction of 3 mutual perpendicular directions | | | | | | | | |
| Mechanical vibration | 1. No case deformation or change in appearance 2. $\Delta\text{L}/\text{Lo} \leq \pm 10\%$ | 1. The test samples shall be soldered to the board. Then it shall be submitted to below test conditions. <table border="1" style="margin: 10px auto;"> <tr> <td>Fre. Range</td> <td>10~55Hz</td> </tr> <tr> <td>Total Amplitude</td> <td>1.5mm</td> </tr> <tr> <td>Sweeping Method</td> <td>10Hz to 55Hz to 10Hz</td> </tr> <tr> <td>Time</td> <td>For 2 hours on each X,Y,Z axis.</td> </tr> </table> 2. Recovery: At least 2 hours of recovery under the standard condition after the test, followed by the measurement within 24 ± 2 hours. | Fre. Range | 10~55Hz | Total Amplitude | 1.5mm | Sweeping Method | 10Hz to 55Hz to 10Hz | Time | For 2 hours on each X,Y,Z axis. |
| Fre. Range | 10~55Hz | | | | | | | | | |
| Total Amplitude | 1.5mm | | | | | | | | | |
| Sweeping Method | 10Hz to 55Hz to 10Hz | | | | | | | | | |
| Time | For 2 hours on each X,Y,Z axis. | | | | | | | | | |
| Thermal Shock | Inductance change: Within $\pm 10\%$ Without distinct damage in appearance | 1. First -55°C for 30 minutes, last 125°C for 30 minutes as 1 cycle. Go through 1000 cycles. 2. Max transfer time is 2 minutes. 3. Measured at room temperature after placing for 24 ± 2 hours | | | | | | | | |
| Humidity Resistance | Inductance change: Within $\pm 10\%$ Without distinct damage in appearance | 1. Reflow 2 times, 2. 85°C , 85%RH, 1000 hours 3. Measured at room temperature after placing for 24 ± 2 hours | | | | | | | | |
| Low temperature storage | Inductance change: Within $\pm 10\%$ Without distinct damage in appearance | 1. Temperature: $-55 \pm 2^{\circ}\text{C}$ 2. Time: 1000 hours 3. Measured at room temperature after placing for 24 ± 2 hours | | | | | | | | |

| | | |
|---------------------------------|--|--|
| <p>High temperature storage</p> | <p>Inductance change: Within $\pm 10\%$ Without distinct damage in appearance</p> | <ol style="list-style-type: none"> 1. Temperature: $+125 \pm 2^\circ\text{C}$ 2. Time: 1000 hours 3. Measured at room temperature after placing for 24 ± 2 hours |
| <p>Board Flex</p> | <p>Inductance change: Within $\pm 10\%$ Without distinct damage in appearance</p> | <ol style="list-style-type: none"> 1. Run through IR reflow for 2 times; 2. Place the 100mm X 40mm board into a fixture similar to the one shown in below Figure with the component facing down 3. The apparatus shall consist of mechanical means to apply a force which will bend the board (D) x = 2 mm minimum. 4. The duration of the applied forces shall be 60 ± 5 sec. The force is to be applied only once to the board.  |
| <p>Terminal Strength</p> | <p>No removal or split of the termination or other defects shall occur.</p> | <ol style="list-style-type: none"> 1. The test samples shall be soldered to the board 2. Push the product vertically from the side of the sample using the thrust tester. 3. Automotive electronics: 17.7N, $60\text{S} \pm 1\text{s}$, X , Y direct.  |

Recommended Soldering Technologies

(1) Re-flowing Profile

Preheat condition: 150 ~200°C/60~180sec.

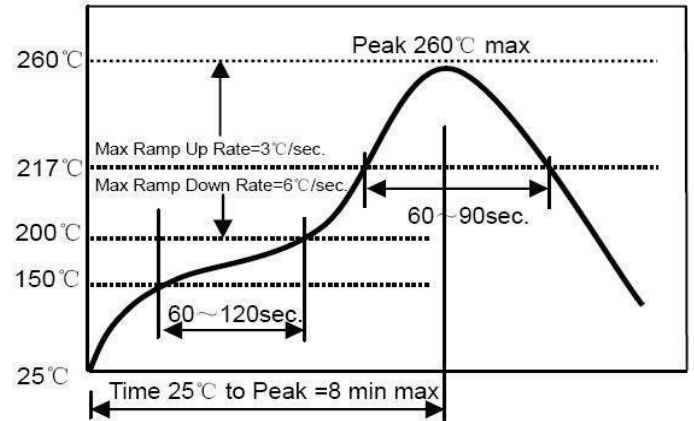
Allowed time above 217°C: 80~120sec.

Max temp: 260°C

Max time at max temp: 10 sec.

Solder paste: Sn/3.0Ag/0.5Cu

Allowed Reflow time: 2x max



(2) Iron Soldering Profile

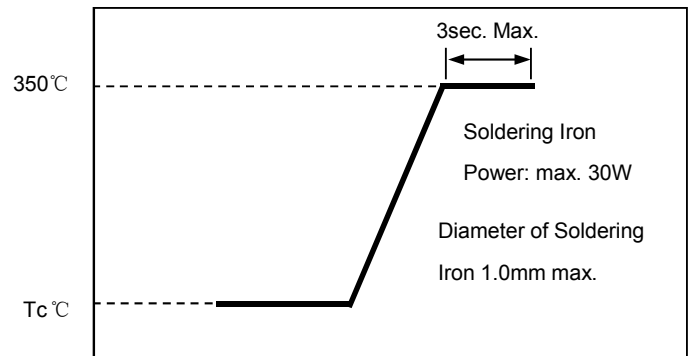
Iron soldering power: Max. 30W

Pre-heating: 150°C/60sec.

Soldering time: 3sec.Max.

Solder paste: Sn/3.0Ag/0.5Cu

Max.1 times for iron soldering

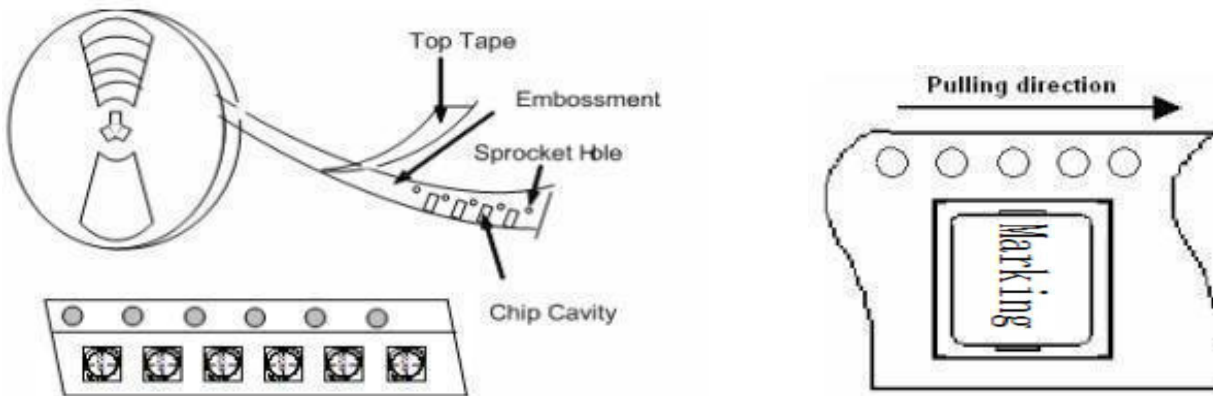


9. Packaging, Storage and Transportation

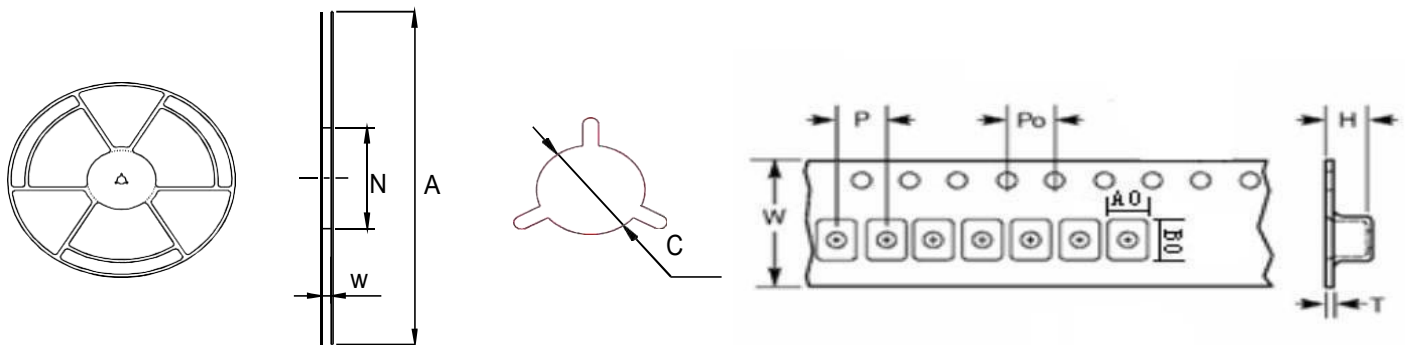
- Tape Carrier Packaging:

| Type | Standard Quantity (pcs/reel) | Type | Standard Quantity (pcs/reel) |
|--------|------------------------------|--------|------------------------------|
| XR0412 | 2000/3000 | XR0640 | 1000 |
| XR0420 | 3000 | XR0650 | 1000 |
| XR0518 | 2000/2500 | XR1040 | 500/1000 |
| XR0520 | 2000/2500 | XR1045 | 800 |
| XR0530 | 1500/2000 | XR1240 | 500 |
| XR0620 | 1000/1500 | XR1250 | 500 |
| XR0624 | 1000/1500 | XR1265 | 400/500 |
| XR0630 | 1000 | | |

- Taping Drawings (UNIT:mm)

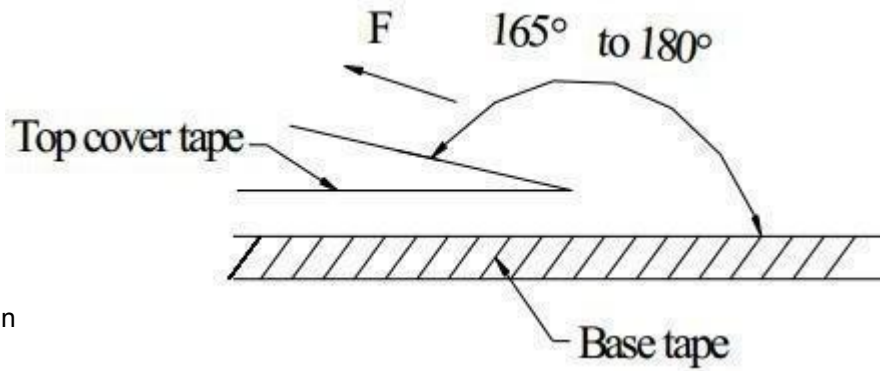


- Reel and Taping Dimensions (UNIT:mm)



| Type | Reel Dimensions (mm) | | | | Tape Dimensions (mm) | | | | | | | |
|--------|----------------------|--------------|---------------|--------------|----------------------|--------|-------|----------|----------|----------|-----------|--|
| | A | N | W | C | W | P | P0 | A0 | B0 | H | T | |
| XR0412 | 330 +2/-0 | 100 +2/-0 | 12.4 +2/-0 | 13.2 ±0.2 | 12±0.3 | 8±0.1 | 4±0.1 | 4.4±0.1 | 4.9±0.1 | 1.5±0.05 | 0.3±0.05 | |
| XR0420 | 330 +2/-0 | 100 +2/-0 | 12.4 +2/-0 | 13.2 ±0.2 | 12±0.3 | 8±0.1 | 4±0.1 | 4.4±0.1 | 4.9±0.1 | 2.3±0.05 | 0.35±0.05 | |
| XR0518 | 330 +2/-0 | 100 +2/-0 | 12.4 +2/-0 | 13.2 ±0.2 | 12±0.3 | 8±0.1 | 4±0.1 | 5.4±0.1 | 5.9±0.1 | 2.1±0.05 | 0.35±0.05 | |
| XR0520 | 330 +2/-0 | 100 +2/-0 | 12.4 +2/-0 | 13.2 ±0.2 | 12±0.3 | 8±0.1 | 4±0.1 | 5.5±0.1 | 5.85±0.1 | 2.2±0.1 | 0.35±0.05 | |
| XR0530 | 330 +2/-0 | 100 +2/-0 | 12.4 +2/-0 | 13.2 ±0.2 | 12±0.3 | 8±0.1 | 4±0.1 | 5.4±0.1 | 5.9±0.1 | 3.3±0.05 | 0.35±0.05 | |
| XR0620 | 330 +2/-0 | 100 +2/-0 | 16.4 +2/-0 | 13.2 ±0.2 | 16±0.3 | 12±0.1 | 4±0.1 | 6.9±0.1 | 7.5±0.1 | 2.1±0.05 | 0.35±0.05 | |
| XR0624 | 330 +2/-0 | 100 +2/-0 | 16.4 +2/-0 | 13.2 ±0.2 | 16±0.3 | 12±0.1 | 4±0.1 | 6.9±0.1 | 7.5±0.1 | 2.7±0.05 | 0.35±0.05 | |
| XR0630 | 330 +2/-0 | 100 +2/-0 | 16.4 +2/-0 | 13.2 ±0.2 | 16±0.3 | 12±0.1 | 4±0.1 | 6.9±0.1 | 7.5±0.1 | 3.3±0.05 | 0.35±0.05 | |
| XR0640 | 330 +2/-0 | 100 +2/-0 | 16.4 +2/-0 | 13.2 ±0.2 | 16±0.3 | 12±0.1 | 4±0.1 | 6.9±0.1 | 7.5±0.1 | 4.2±0.1 | 0.35±0.05 | |
| XR0650 | 330 +2/-0 | 100 +2/-0 | 16.4 +2/-0 | 13.2 ±0.2 | 16±0.3 | 12±0.1 | 4±0.1 | 6.9±0.1 | 7.5±0.1 | 5.2±0.1 | 0.4±0.05 | |
| XR1040 | 330 +2/-0 | 100 +2/-0 | 24.4 +2/-0 | 13.2 ±0.2 | 24±0.3 | 16±0.1 | 4±0.1 | 10.4±0.1 | 11.5±0.1 | 4.3±0.1 | 0.35±0.05 | |
| XR1045 | 330 +2/-0 | 100 +2/-0 | 24.4 +2/-0 | 13.2 ±0.2 | 24±0.3 | 16±0.1 | 4±0.1 | 10.4±0.1 | 11.5±0.1 | 4.8±0.1 | 0.35±0.05 | |
| XR1240 | 330 +2/-0 | 100 +2/-0 | 24.4 +2/-0 | 13.2 ±0.2 | 24±0.3 | 16±0.1 | 4±0.1 | 13.4±0.1 | 14.4±0.1 | 4.3±0.1 | 0.5±0.05 | |
| XR1250 | 330 +2/-0 | 100 +2/-0 | 24.4 +2/-0 | 13.2 ±0.2 | 24±0.3 | 16±0.1 | 4±0.1 | 13.2±0.1 | 14.4±0.1 | 5.3±0.1 | 0.5±0.05 | |
| XR1265 | 330 +2/-0 | 100 +2/-0 | 24.4 +2/-0 | 13.2 ±0.2 | 24±0.3 | 16±0.1 | 4±0.1 | 13.2±0.1 | 14.4±0.1 | 6.3±0.1 | 0.5±0.05 | |

- Peel force of top cover tape
The peel speed shall be about 300mm/minute
The peel force of top cover tape shall be between 0.1 to 1.3 N



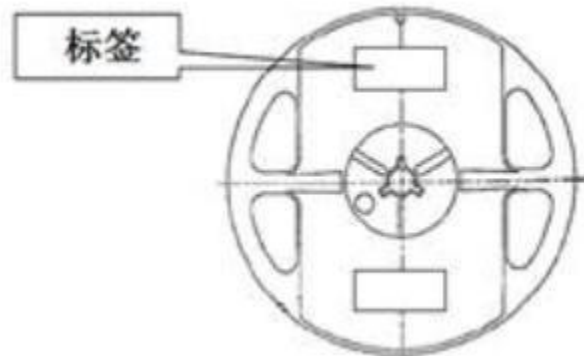
- Label makin

Label on the reel

- Customer's part Number
- Lot Number
- Quantity
- date code

Shipping Label

- Customer's part Number
- Manufacturer's part Number
- Quantity
- date code



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[MHQ1005P5N1S](#) [MHQ1005P8N2J](#) [PE-53601NL](#) [PE-53602NL](#) [PG0936.113NLT](#) [9220-20](#) [9310-16](#) [PM06-2N7](#) [PM06-39NJ](#) [A01TK](#)
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